

#### Description

The DMN3404L uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

 $V_{DS} = 30V I_{D} = 5.8A$ 

 $R_{DS(ON)}$  < 28m $\Omega$  @ V<sub>GS</sub>=10V

#### Application

Battery protection

Load switch Uninterruptible power supply

#### Package Marking and Ordering Information

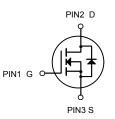
Product ID	Pack	Brand	Qty(PCS)
DMN3404L	SOT-23	HXY MOSFET	3000

### Absolute Maximum Ratings (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Symbol	Parameter	Limit	Unit
Vds	Drain-Source Voltage	30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
ID	Drain Current-Continuous	5.8	A
Ом	Drain Current-Pulsed (Note 1)	18.4	A
P <sub>D</sub>	Maximum Power Dissipation	1	W
Tj,Tstg	Operating Junction and Storage Temperature Range	-55 To 150	°C
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	125	°C/W







N-Channel MOSFET



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V	
$\triangle BV_{DSS} / \triangle T$	BVDSS Temperature Coefficient	Reference to $25^{\circ}$ C , I <sub>D</sub> =1mA		0.023		V/°C	
Rds(on)	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =4A		22	28	mΩ	
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =3A		26	32		
V <sub>GS(th)</sub>	Gate Threshold Voltage	VGS=VDS . ID =250uA	1.0	1.5	2.5	V	
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS, ID -2500A		-4.2		mV/°C	
l	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA	
IDSS		V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA	
Igss	Gate-Source Leakage Current	V <sub>GS=</sub> ±20V , V <sub>DS</sub> =0V			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =4A		7		S	
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.3	4.6	Ω	
Qg	Total Gate Charge (4.5V)			5.0	6.9		
Qgs	Gate-Source Charge	$V_{DS}$ =15V , $V_{GS}$ =4.5V , $I_{D}$ =4A		1.1	2.2	nC	
$Q_{gd}$	Gate-Drain Charge			2.6	2.8		
T <sub>d(on)</sub>	Turn-On Delay Time			2	4		
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_G$ =3.3 $\Omega$		34.4	62		
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =4A		13.2	26	ns	
T <sub>f</sub>	Fall Time			4.8	9.6		
Ciss	Input Capacitance			420	582		
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		60	87	pF	
Crss	Reverse Transfer Capacitance			53	71		

#### **Diode Characteristics**

Symbol	Parameter	Conditions		Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,4</sup>				4.6	А
lsм	Pulsed Source Current <sup>2,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			18.4	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup> V <sub>Gs</sub>	s=0V , Is=1A , TJ=25°C			1.2	V
trr	Reverse Recovery Time			8.7		nS
Qrr	Reverse Recovery Charge	4A , dI/dt=100A/μs , Tյ=25°C		2.3		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3. The power dissipation is limited by 150°C junction temperature

4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

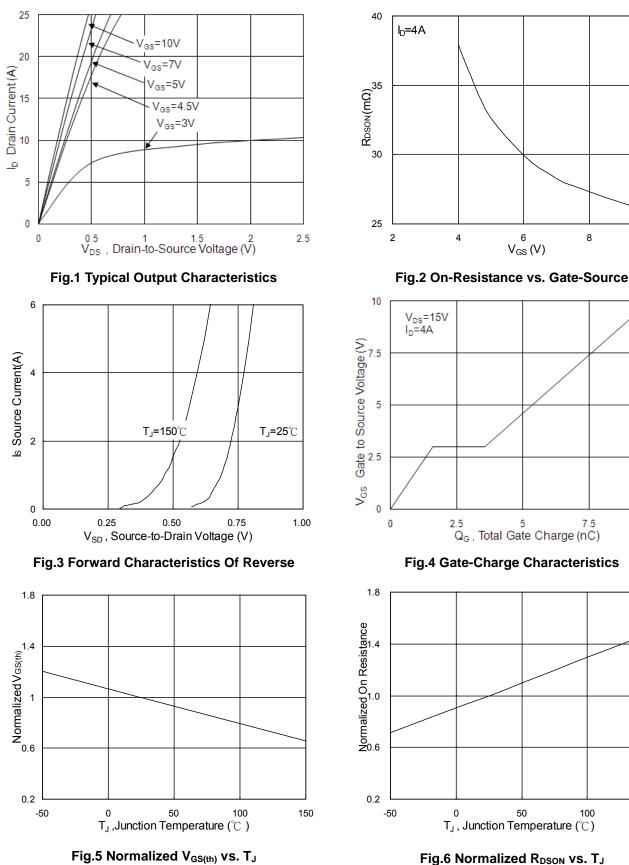


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10

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## **Typical Characteristics**



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Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

150

100



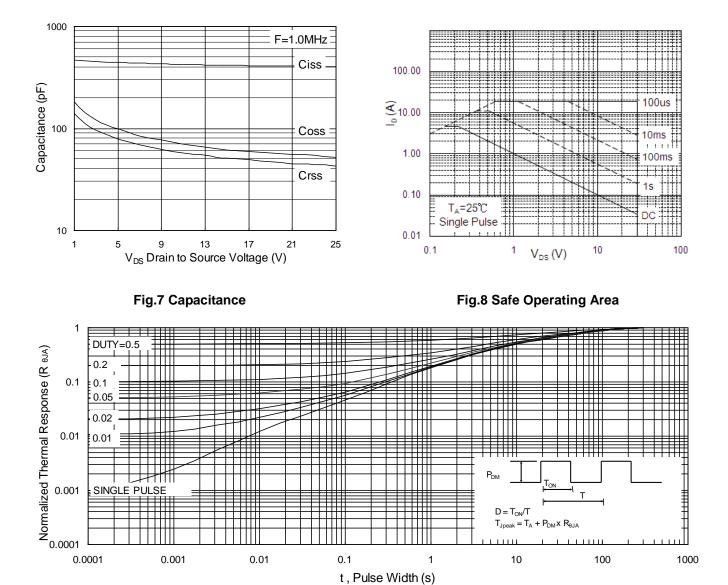
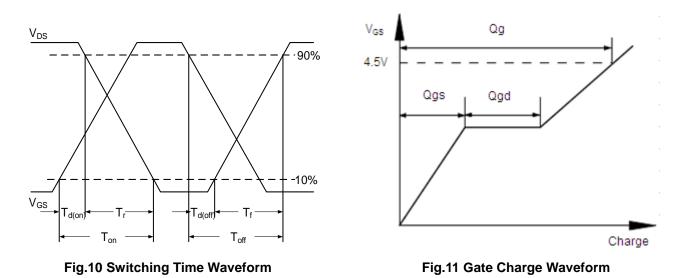


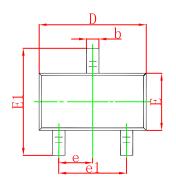
Fig.9 Normalized Maximum Transient Thermal Impedance

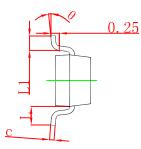


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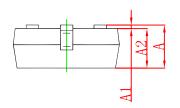


# **SOT-23 Package Outline Dimensions**



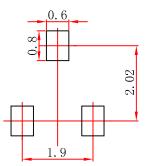


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Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950	0.950 TYP		' TYP	
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

# SOT-23 Suggested Pad Layout



Note: 1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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